Onsemi

IGBT – Power, Co-PAK **N-Channel, Field Stop VII** (FS7), SCR, T0247-3L 1200 V, 1.42 V, 40 A AFGHL40T120RWD

Description

Using the novel field stop 7th generation IGBT technology and the Gen7 Diode in TO247 3-lead package, this device offers the optimum performance with low on state voltage and minimal switching losses for both hard and soft switching topologies in automotive applications.

Features

- Extremely Efficient Trench with Field Stop Technology
- Maximum Junction Temperature T_J =175°C
- Short Circuit Rated and Low Saturation Voltage
- Fast Switching and Tightened Parameter Distribution
- AEC-Q101 Qualified, PPAP Available Upon Request
- This Device is Pb-Free, Halogen Free/BFR Free and is RoHS Compliant

Applications

• Automotive E-compressor / Automotive EV PTC Heater / OBC

MAXIMUM RATINGS (T₁ = 25°C unless otherwise noted)

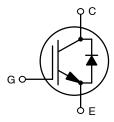
$\begin{array}{c c c c c c c } \hline Collector-to-Emitter Voltage & V_{CE} & 1200 & V_{GE} & \pm 20 & \\ \hline Collector-Emitter Voltage & V_{GE} & \pm 20 & \\ \hline Transient Gate-to-Emitter Voltage & & \pm 30 & \\ \hline Transient Gate-to-Emitter Voltage & & \pm 30 & \\ \hline Collector Current & T_{C} = 25^{\circ}C & I_{C} & 80 & A & \\ \hline T_{C} = 100^{\circ}C & & 40 & \\ \hline Power Dissipation & T_{C} = 25^{\circ}C & P_{D} & 652 & W & \\ \hline T_{C} = 100^{\circ}C & & 326 & \\ \hline Pulsed Collector & T_{C} = 25^{\circ}C, & I_{CM} & 120 & A & \\ \hline Diode Forward & T_{C} = 25^{\circ}C, & I_{F} & 80 & \\ \hline T_{C} = 100^{\circ}C & & 40 & \\ \hline Diode Forward & T_{C} = 25^{\circ}C, & I_{F} & 80 & \\ \hline T_{C} = 100^{\circ}C & & 40 & \\ \hline Pulsed Diode Maximum & T_{C} = 25^{\circ}C, & I_{FM} & 120 & \\ \hline Pulsed Diode Maximum & T_{C} = 25^{\circ}C, & I_{FM} & 120 & \\ \hline Short Circuit Withstand Time & T_{C} = 25^{\circ}C, & I_{FM} & 120 & \\ \hline Short Circuit Withstand Time & T_{C} = 150^{\circ}C & & \\ \hline Operating Junction and Storage Temperature & T_{J}, T_{stg} & -55 \text{ to} \\ \hline Range & & \hline \end{array}$		(1) = 25 O unless other	wise noted)		
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Param	eter	Symbol	Value	Unit
$\begin{tabular}{ c c c c } \hline Transient Gate-to-Emitter Voltage & \pm 30 \\ \hline Tc = 25^\circ C & Ic & 80 & A \\ \hline Tc = 100^\circ C & 40 & \\ \hline Tc = 100^\circ C & P_D & 652 & W \\ \hline Tc = 100^\circ C & 326 & \\ \hline Tc = 100^\circ C & & \\ \hline Tc = 25^\circ C, & IcM & 120 & \\ \hline Pulsed Collector & T_C = 25^\circ C, & IcM & 120 & \\ \hline Pulsed Collector & T_C = 25^\circ C, & IcM & 120 & \\ \hline Diode Forward & T_C = 25^\circ C & IF & 80 & \\ \hline Tc = 100^\circ C & & 40 & \\ \hline Pulsed Diode Maximum & T_C = 25^\circ C, & IF & 80 & \\ \hline Pulsed Diode Maximum & T_C = 25^\circ C, & IF & 80 & \\ \hline Pulsed Diode Maximum & T_C = 25^\circ C, & IF & 80 & \\ \hline Pulsed Diode Maximum & T_C = 25^\circ C, & IF & 80 & \\ \hline Short Circuit Withstand Time & T_C = 150^\circ C & T_SC & 6 & \mu s & \\ \hline VgE = 15 V, V_{CC} = 800 V, T_C = 150^\circ C & T_J, T_{stg} & -55 & to \\ \hline Range & T_J, T_{stg} & -55 & to \\ \hline Range & T_J, T_{stg} & -55 & to \\ \hline Tc = 100^\circ C & T_SC & C & \\ \hline Tc = 100^\circ C & T_SC & C & \\ \hline Tc = 100^\circ C & T_SC & C & \\ \hline Tc = 100^\circ C & T_SC & C & \\ \hline Tc = 150^$	Collector-to-Emitter Volta	age	V _{CE}	1200	V
$\begin{tabular}{ c c c c c } \hline Collector Current & $T_C = 25^\circ C$ & I_C & 80 & A \\ \hline $T_C = 100^\circ C$ & 40 & 40 & 40 & 40 & 40 & 10 & $T_C = 25^\circ C$ & P_D & 652 & W & $$T_C = 100^\circ C$ & 326 & $1CM$ & 120 & 326 & $1CM$ & 120 & $1CM$ & $1CM$ & 120 & $1CM$ & $1CM$ & 120 & $1CM$ & $1C$	Gate-to-Emitter Voltage		V _{GE}	±20	
$\begin{tabular}{ c c c c c } \hline & & & & & & & & & & & & & & & & & & $	Transient Gate-to-Emitte	er Voltage		±30	
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Collector Current	$T_{C} = 25^{\circ}C$	۱ _C	80	А
$\begin{tabular}{ c c c c c c c c c c } \hline T_C &= 100^\circ C & 326 \\ \hline T_C &= 100^\circ C & T_C &= 25^\circ C, \\ tp &= 10 \ \mu s \ (Note \ 1) & I_{CM} & 120 & A \\ \hline Diode \ Forward & $T_C &= 25^\circ C$ & I_F & 80 \\ \hline T_C &= 100^\circ C & 40 \\ \hline Pulsed \ Diode \ Maximum & $T_C &= 25^\circ C$, \\ tp &= 10 \ \mu s \ (Note \ 1) & I_{FM} & 120 \\ \hline Pulsed \ Diode \ Maximum & $T_C &= 25^\circ C$, \\ tp &= 10 \ \mu s \ (Note \ 1) & I_F & 120 \\ \hline Short \ Circuit \ Withstand \ Time & $T_C &= 150^\circ C$ & $T_{SC} & 6$ & μs \\ \hline Operating \ Junction \ and \ Storage \ Temperature & $T_J, \ T_{stg} & -55 to $+175$ \\ \hline \end{tabular}$		T _C = 100°C		40	
$\begin{array}{c c} Pulsed Collector \\ Current \\ \end{array} \begin{array}{c} T_{C} = 25^{\circ}C, \\ tp = 10 \ \mu s \ (Note 1) \\ \end{array} \begin{array}{c} I_{CM} \\ tp = 10 \ \mu s \ (Note 1) \\ \end{array} \begin{array}{c} I_{CM} \\ \end{array} \begin{array}{c} I_{20} \\ \end{array} \begin{array}{c} A \\ \end{array} \begin{array}{c} A \\ \hline \\ A \\ \hline $	Power Dissipation	T _C = 25°C	PD	652	W
$\begin{tabular}{ c c c c c c } \hline Current & tp = 10 \ \mu s \ (Note 1) & T_C & CW & T_C & T_C & 25^\circ C & I_F & 80 & T_C & 100^\circ C & 40 & 40 & 0 & 0 & 0 & 0 & 0 & 0 & 0 &$	Dulaad Callector	T _C = 100°C		326	
$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$			I _{CM}	120	A
$\begin{tabular}{ c c c c c c } \hline T_C &= 100^\circ C & 40 \\ \hline Pulsed Diode Maximum & $T_C = 25^\circ C$, $$$ tp = 10 \ \mu s (Note 1)$ & I_{FM} & 120 \\ \hline Short Circuit Withstand Time $$$$ volume V_{GE} &= 15 \ V$, $V_{CC} = 800 \ V$, $T_C = 150^\circ C$ & T_{SC} & 6 & $$$$ \mus $$ $$ $$ $$ $$ Operating Junction and Storage Temperature $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$$		$T_{C} = 25^{\circ}C$	١ _F	80	A
Forward Currenttp = 10 μ s (Note 1)TmShort Circuit Withstand Time V _{GE} = 15 V, V _{CC} = 800 V, T _C = 150°CT _{SC} 6Operating Junction and Storage Temperature RangeT _J , T _{stg} -55 to +175	Current	T _C = 100°C		40	
V_{GE} = 15 V, V_{CC} = 800 V, T_C = 150°CTJ, T_{stg} -55 toOperating Junction and Storage Temperature RangeTJ, T_{stg} -55 to+175			I _{FM}	120	
Range +175			T _{SC}	6	μs
Lead Temperature for Soldering Purposes T ₁ 260	0	torage Temperature	T _J , T _{stg}		°C
, J J ,	Lead Temperature for Sol	dering Purposes	ΤL	260	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Repetitive rating: Pulse width limited by max. junction temperature

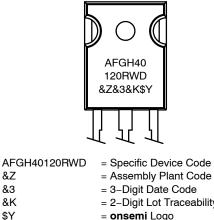
BV _{CES}	V _{CE(sat)} TYP	I _C MAX
1200 V	1.42 V	40 A

PIN CONNECTIONS





MARKING DIAGRAM



- = 2-Digit Lot Traceability Code
- = onsemi Logo

ORDERING INFORMATION

Device	Package	Shipping
AFGHL40T120RWD	TO-247-3L (Pb-Free)	30 Units / Tube

THERMAL CHARACTERISTICS

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case for IGBT		0.23	°C/W
Thermal Resistance, Junction-to-Case for Diode	R _{0JCD}	0.41	
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	40	

ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

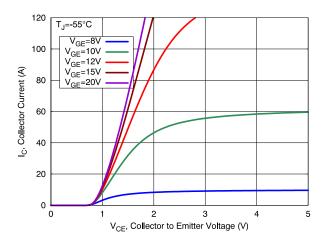
Parameter	Symbol	Test Conditions	Min	Тур	Мах	Unit
OFF CHARACTERISTICS				-		
Collector-to-Emitter Breakdown Voltage	BV _{CES}	V _{GE} = 0 V, I _C = 1 mA	1200	-	-	V
Collector-to-Emitter Breakdown Voltage Temperature Coefficient	$\Delta BV_{CES}/\Delta T_{J}$	V _{GE} = 0 V, I _C = 9.99 mA	_	1226	-	mV/°C
Zero Gate Voltage Collector Current	I _{CES}	V_{GE} = 0 V, V_{CE} = V_{CES}	-	-	40	μA
Gate-to-Emitter Leakage Current	I _{GES}	V_{GE} = ±20 V, V_{CE} = 0 V	-	-	±400	nA
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GE(th)}	V_{GE} = V_{CE} , I_C = 40 mA	5.03	5.93	6.83	V
Collector-to-Emitter Saturation	V _{CE(sat)}	V_{GE} = 15 V, I _C = 40 A, T _J = 25°C	-	1.42	1.75	V
Voltage		V_{GE} = 15 V, I _C = 40 A, T _J = 175°C	-	1.71	-	1
DYNAMIC CHARACTERISTICS						
Input Capacitance	CIES	V_{CE} = 30 V, V_{GE} = 0 V, f = 1 MHz	_	4714	-	pF
Output Capacitance	C _{OES}		-	195	-	-
Reverse Transfer Capacitance	C _{RES}		-	23.7	-	
Total Gate Charge	Q _G	V _{CE} = 600 V, V _{GE} = 15 V,	-	170	-	nC
Gate-to-Emitter Charge	Q _{GE}	I _C = 40 A	-	42.2	-	
Gate-to-Collector Charge	Q _{GC}		-	73.1	-	
SWITCHING CHARACTERISTICS						-
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 \text{ V}, V_{GE} = 0/15 \text{ V},$	-	50.1	-	ms
Turn-Off Delay Time	t _{d(off)}	I _C = 20 A, R _G = 4.7 Ω, T _J = 25°C	-	293	-	
Rise Time	t _r		-	30.9	-	
Fall Time	t _f		-	189	-	
Turn-On Switching Loss	E _{on}		-	1.37	-	
Turn-Off Switching Loss	E _{off}		-	1.35	-	
Total Switching Loss	E _{ts}	1	-	2.72	-	
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 \text{ V}, \text{ V}_{GE} = 0/15 \text{ V},$	_	55.2	_	ns
Turn-Off Delay Time	t _{d(off)}	I _C = 40 A, R _G = 4.7 Ω, T _J = 25°C	-	241	-	
Rise Time	t _r		_	55.2	_	
Fall Time	t _f		_	122	-	1
Turn-On Switching Loss	E _{on}		-	3.68	-	mJ
Turn-Off Switching Loss	E _{off}		_	1.7	_	
Total Switching Loss	E _{ts}		-	5.38	_	

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise specified)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS						
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 \text{ V}, \text{ V}_{GE} = 0/15 \text{ V},$	-	56	_	ns
Turn-Off Delay Time	t _{d(off)}	l _C = 20 A, R _G = 4.7 Ω, T _{.I} = 175°C	-	414	-	
Rise Time	tr		-	41.7	_	
Fall Time	t _f		-	375	-	
Turn–On Switching Loss	E _{on}		-	2.13	-	mJ
Turn–Off Switching Loss	E _{off}		-	2.51	_	
Total Switching Loss	E _{ts}		-	4.64	-	
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 600 \text{ V}, \text{ V}_{GE} = 0/15 \text{ V},$	-	63.1	-	ns
Turn-Off Delay Time	t _{d(off)}	I _C = 40 A, R _G = 4.7 Ω, T _J = 175°C	-	325	-	
Rise Time	t _r		-	71.2	-	1
Fall Time	t _f		-	233	-	
Turn–On Switching Loss	E _{on}		-	5.75	-	mJ
Turn–Off Switching Loss	E _{off}		-	3.03	-	
Total Switching Loss	E _{ts}		-	8.79	_	
DIODE CHARACTERISTICS						
Forward Voltage	V _F	$I_F = 40 \text{ A}, \text{ T}_J = 25^{\circ}\text{C}$	-	1.51	1.81	V
		I _F = 40 A, T _J = 175°C	-	1.51	_	1
DIODE SWITCHING CHARACTERIS	TICS, INDUCTIVE	E LOAD				
Reverse Recovery Time	t _{rr}	$V_{\rm R} = 600 \text{ V}, I_{\rm F} = 20 \text{ A},$	-	147	-	ns
Reverse Recovery Charge	Q _{rr}	dI _F /dt = 500 A/µs, T _J = 25°C	-	2110	-	nC
Reverse Recovery Energy	E _{rec}		-	0.53	-	mJ
Peak Reverse Recovery Current	I _{RRM}		-	33.5	-	Α
Reverse Recovery Time	t _{rr}	$V_{\rm R} = 600 \text{ V}, I_{\rm F} = 40 \text{ A},$	-	185	-	ns
Reverse Recovery Charge	Q _{rr}	$dI_F/dt = 500 \text{ A}/\mu \text{s}, \text{ T}_J = 25^{\circ}\text{C}$	-	3612	-	nC
Reverse Recovery Energy	E _{rec}		-	0.78	-	mJ
Peak Reverse Recovery Current	I _{RRM}	1	-	43.2	_	Α
Reverse Recovery Time	t _{rr}	$V_{\rm R} = 600 \text{ V}, I_{\rm F} = 20 \text{ A},$	-	207	-	ns
Reverse Recovery Charge	Q _{rr}	dl _F /dt = 500 A/µs, T _J = 175°C	-	3670	-	nC
Reverse Recovery Energy	E _{rec}		-	1.1	-	mJ
Peak Reverse Recovery Current	I _{RRM}		-	41.5	-	Α
Reverse Recovery Time	t _{rr}	V _R = 600 V, I _F = 40 A, dI _F /dt = 500 A/μs, T _J = 175°C	-	258	-	ns
Reverse Recovery Charge	Q _{rr}		-	6684	-	nC
Reverse Recovery Energy	E _{rec}		-	1.66	_	mJ
Peak Reverse Recovery Current	I _{RRM}		_	56.5	_	Α

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS





120

100

80

60

40

20

I_C, Collector Current (A)

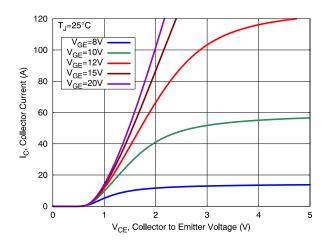
T_J=175°C

V_{GE}=8V

V_{GE}=10V V_{GE}=12V

V_{GE}=15V

V_{GE}=20V





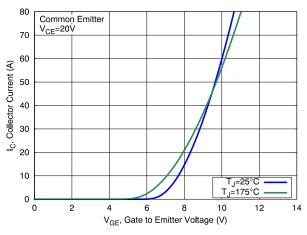
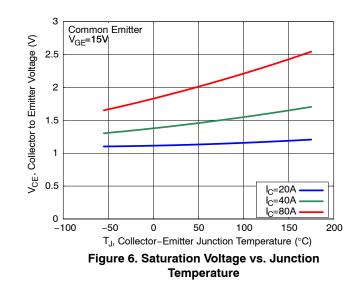


Figure 4. Transfer Characteristics



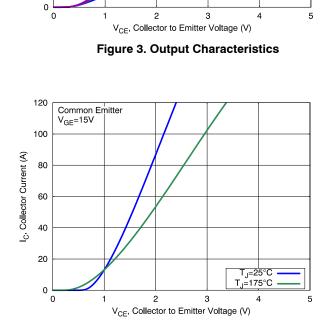


Figure 5. Saturation Characteristics

TYPICAL CHARACTERISTICS

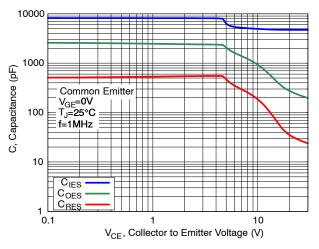
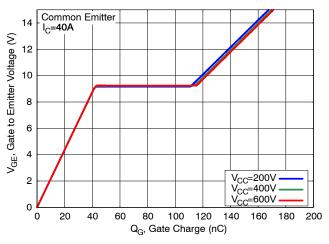
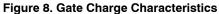


Figure 7. Capacitance Characteristics





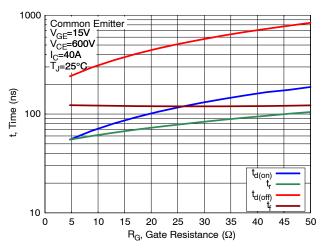


Figure 9. Switching Time vs. Gate Resistance

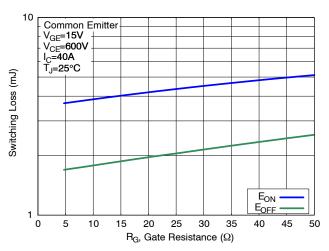


Figure 11. Switching Loss vs. Gate Resistance

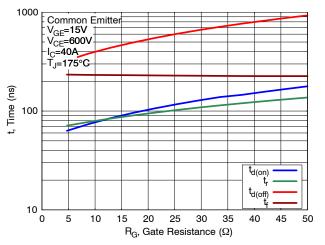


Figure 10. Switching Time vs. Gate Resistance

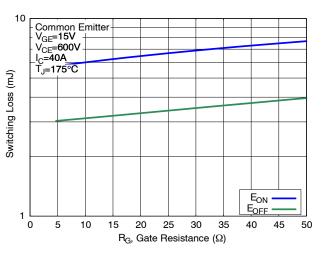
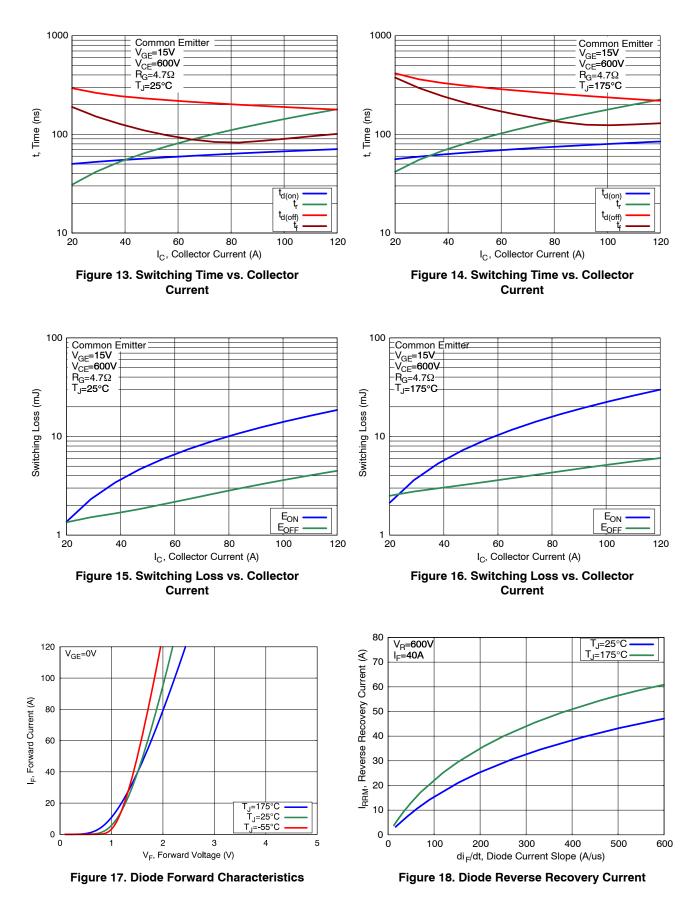
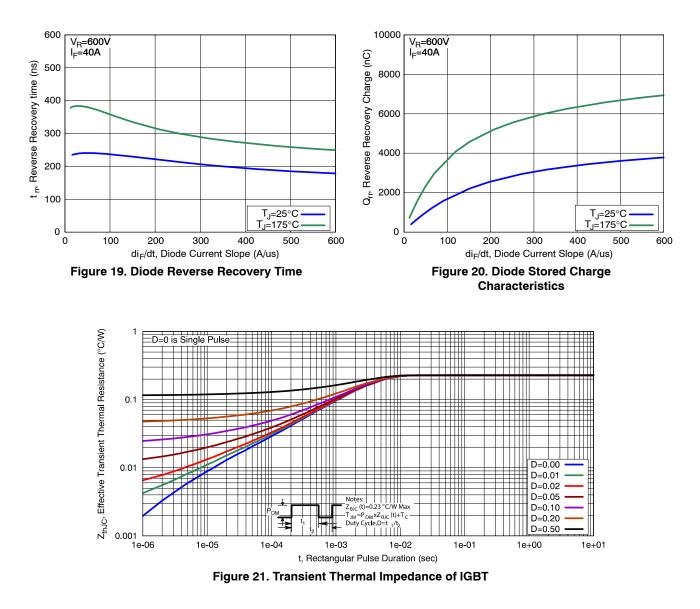


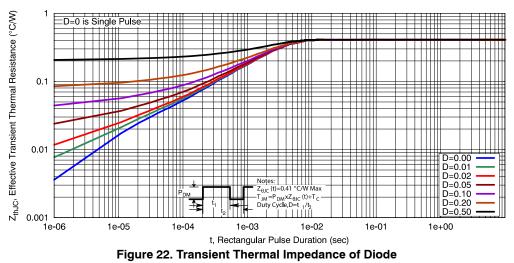
Figure 12. Switching Loss vs. Gate Resistance

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS





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